ASSIGNMENT RECORDATION FOR

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102545580 To: Commissioner for Patents: Date: August 28, 2003 Please record the attached original documents or copy thereof. Attorney Docket No. 5649-1139 1. Name of conveying party(ies): 2. Name and address of receiving party(ies): A. Sung-hoon Kim Samsung Electronics Co., Ltd. 416 Maetan-dong Paldal-ku, Suwon Kyunggi-do, Republic of Korea 09/03/2003 DTESSEMI 00000035 10651181 Additional name(s) of conveying party(ies) attached? 04 FC:8021 40.00 00 Nature of conveyance: x Assignment Merger Security Agreement Additional name(s) & address(es) attached? ___ Yes x No Change of Name Other Execution Date: A. August 11, 2003 4. Application Serial No. _____Patent No. -10/658/81 If this document is being filed together with a new application, the execution date of the application is: August 28, 2003 Additional numbers attached? Yes x No 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: 7. Total fee (37 CFR 3.41) \$40.00 x Enclosed Scott C. Hatfield, Esq. Myers Bigel Sibley & Sajovec _ Authorized to be charged to deposit account P. O. Box 37428 Raleigh NC 27627 8. Deposit account number: 50-0220 DO NOT USE THIS SPACE 9. Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Scott C. Hatfield, Reg. No. 38,176 Name of Person Signing Signature ! Total number of pages including cover sheet, attachments and document: CERTIFICATE OF MAILING UNDER 37 CFR §1.8 I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: MS Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on August 28, 2003. Joyce Paol

> **PATENT** REEL: 014459 FRAME: 0269

ASSIGNMENT

THIS ASSIGNMENT, made by me, **Sung-hoon Kim**, a citizen of the Republic of Korea, residing at 101-304, Shibeom danji Samsung Apt., Seohyun-dong, Bundang-gu, Sungnam-city, Kyungki-do, Republic of Korea;

WITNESSETH: That,

WHEREAS, Samsung Electronics Co., Ltd, a Korean corporation having a principal place of business at 416, Maetan-dong, Paldal-ku, Suwon, Kyunggi-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I have sold and by these presents do hereby sell, assign, transfer, and convey unto the said assignee, its successors and assigns, the entire right, title, and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues or other forms of protection thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted along with any term extensions thereon or therefor, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if this assignment and

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sale had not been made.

I hereby request that said Letters Patent be issued in accordance with this assignment.

I further covenant and agree that, at the time of the execution and delivery of these presents, I possess full title to the invention and application above-mentioned, and that I have the unencumbered right and authority to make this assignment.

I further covenant and agree to communicate to said assignee or its representatives any facts known to me relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors, or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns, and other legal representatives; and I hereby instruct, and further covenant and agree to bind my heirs, legal representatives, and assigns, to do same, without further compensation, but at the expense of said assignee or its representatives.

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IN WITNESS WHE	REOF, I have hereunto	set my har	nd and seal on this
of Avgust , 2003			
_	Sung-Hoon SUNG-HOON KIM	Kim	(SEAL)
S	SUNG-HOON KIM		
Witness			

RECORDED: 08/29/2003

11th day